| ASEDCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® Material Comp<br>© Copyright 2005. 1<br>international and Par | PC. Bannockl  | ourn, Illinois, A     | ll rights reserved untions. | under both              | This docume<br>level parts, t  | ent is a declaration ended and the declaration ended | on of the su<br>compasses               | bstances v<br>all lower | vithin the manufact<br>level materials for | urer listed which the   | item. Note:<br>manufactur       | if the item is an as<br>er has engineering | sembly with low responsibility. |  |
|---|---------------|-----------------------|-----------------------------|-------------------------|--|--|---|-------------------------|--|-------------------------|---------------------------------|--|---------------------------------|--|
|   |               |                       |                             | Form Type<br>Distribute | e * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |  |   |                         | rials and N                                | als and Mfg Information |                                 |  |                                 |  |
| Supplier Information  |               |                       |                             |                         |  |  |   |                         |  |                         |                                 |  |                                 |  |
| Company name* Con   |               |                       | Company unique ID           |                         |  | Unique ID Authority                                  |   |                         |  | Respor                  | Response Date*                  |  |                                 |  |
| onsemi  |               |                       |                             |                         |  |  |   |                         |  | 2023-0                  | 2023-06-08                      |  |                                 |  |
| ontact Name Title - Contact   |               |                       | et                          |                         | Phone - Contact*   |  |   |                         | Email - Contact*                           |                         |                                 |  |                                 |  |
| Product-Env-Stewards Product Envi   |               |                       | viro Compliance             |                         |  | NA   |   |                         |  | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Represe  |               |                       | sentative                   |                         |  | Phone - Representative*                              |   |                         | Email                                      | Email - Representative* |                                 |  |                                 |  |
| Product-Env-Stewards Produ  |               |                       | Product Enviro Compliance   |                         |  | NA   |   |                         |  | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number   | Mfr Iten      | n Number              | Mfr Item Name               |                         |  | Effective Date                                       | ctive Date Version Manufacturing Sit    |                         | anufacturing Site                          |                         | Weight*                         | UOM  | Unit Type                       |  |
|   | 74LCX1        | X157M QUAD 2-INPUT M  |                             | ' MUX (3V)              |  | 2023-06-08   |   | PI                      | PH4  |                         | 147.797                         | mg   | Each                            |  |
| Aanufacturing Proccess Informa  | tion          |                       |                             |                         |  |  |   |                         |  |                         |                                 |  |                                 |  |
| Terminal Plating / Grid Array M   | aterial 7     | l Terminal Base Alloy |                             | J-STD-020 MSI           | Rating   | Peak Proce   | ocess Body Temperature Max Time at Peak |                         | k Tempera                                  | ture Nun                | nber of Reflow Cyc              | les  |                                 |  |
| Matte Tin (Sn) - annealed CU Allo   |               | CU Alloy              | 1                           |                         |  | 260  | 260 C                                   |                         | 30   | seco                    | nds 3                           |  |                                 |  |
| omments   |               |                       |                             |                         |  |  |   |                         |  |                         |                                 |  |                                 |  |
| vel 1 - maximum time at peak temperatu  | ire during so | ldering is 10-3       | 0 seconds                   |                         |  |  |   |                         |  |                         |                                 |  |                                 |  |
| or more information regarding material  | composition   | please refer to       | page 3                      |                         |  |  |   |                         |  |                         |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | Supplier Acceptance  | * Accepted  |   |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance   | CAS        | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|---|------------|--------|---------|-----------------|
| Die                  | 4.35   | mg              | Supplier | Silicon (Si)  | 7440-21-3  |        | 4.35    | mg              |
| Die Attach Epoxy     | 0.44   | mg              | Supplier | Silver (Ag)   | 7440-22-4  |        | 0.4048  | mg              |
|                      |        |                 | Supplier | Phenolic Resin-2  | 54208-63-8 |        | 0.0352  | mg              |
| Lead Frame           | 46.4   | mg              | Supplier | Silver (Ag)   | 7440-22-4  |        | 0.2042  | mg              |
|                      |        |                 | Supplier | Zinc (Zn)   | 7440-66-6  |        | 0.0603  | mg              |
|                      |        |                 | Supplier | Iron (Fe)   | 7439-89-6  |        | 1.1136  | mg              |
|                      |        |                 | Supplier | Copper (Cu)   | 7440-50-8  |        | 45.0034 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)  | 7723-14-0  |        | 0.0186  | mg              |
| Mold Compound-Black  | 93.9   | mg              | Supplier | 2,6-dibromo-4-[1-(3-bromo-4-<br>hydroxyphenyl)-1-methylethyl]phenol | 6386-73-8  |        | 0.939   | mg              |
|                      |        |                 | Supplier | Ortho Cresol Novolac Resin  | 29690-82-2 |        | 27.231  | mg              |
|                      |        |                 | В        | Antimony Trioxide (Sb2O3)   | 1309-64-4  |        | 1.878   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)  | 1333-86-4  |        | 0.704   | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)   | 60676-86-0 |        | 63.148  | mg              |
| Plating              | 2.31   | mg              | Supplier | Tin (Sn)  | 7440-31-5  |        | 2.31    | mg              |
| Wire Bond - Au       | 0.397  | mg              | Supplier | Gold (Au)   | 7440-57-5  |        | 0.397   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).